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PEOPLE'S REPUBLIC OF CHINA

GB/T 17473.7-1998

Test methods of precious metal pastes used for thick-film microelectronics--Test of solderability and solderleaching resistance

厚膜微电子技术用贵金属浆料测试方法 可焊性、耐焊性试验

(English Translation)

Issued on: August 19, 1998 **Implemented on: March 1, 1999**

Issued by: State Quality Technical Supervision Bureau

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Document data

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Sector: National standard (Recommended).

Issuing body: State Quality Technical Supervision Bureau.

Date of issue: 1998-08-19.

Date of implementation: 1999-03-01.

Status: obsolete, replaced by GB/T 17473.7-2008.

Preview: page 2 of 2 shown, full document available. Complete English PDF, instant download:
https://chinastandards.org/standards/gb-t-17473-7-1998